

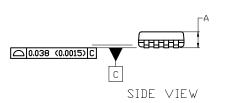


Micro8 CASE 846A-02 ISSUE K

DATE 16 JUL 2020

Α $\mathbf{H}\mathbf{H}\mathbf{H}\mathbf{H}$ DETAIL A **♦** 0.08 (0.003)**₩** C BS AS



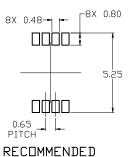




END VIEW

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- CONTROLLING DIMENSION: MILLIMETERS
- DIMENSION 6 DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.10 mm IN EXCESS OF MAXIMUM MATERIAL CONDITION.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 mm PER SIDE. DIMENSION E DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 mm PER SIDE. DIMENSIONS D AND E ARE DETERMINED AT DATUM F.
- DATUMS A AND B ARE TO BE DETERMINED AT DATUM F.
- A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT ON THE PACKAGE BODY.



MOUNTING FOOTPRINT

DIM	MI	RS		
ואונע	MIN.	N□M.	MAX.	
Α			1.10	
A1	0.05	0.08	0.15	
b	0.25	0.33	0.40	
С	0.13	0.18	0.23	
D	2.90	3.00	3.10	
E	2.90	3.10		
e	0.65 BSC			
HE	4.75	4.90	5.05	
	0.40	0.55	0.70	

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code Α = Assembly Location

Υ = Year W = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

STYLE 1:	STYLE 2:		STYLE 3:	
PIN 1. SOURCE	PIN 1.	SOURCE 1	PIN 1.	N-SOURCE
SOURCE	2.	GATE 1	2.	N-GATE
SOURCE	3.	SOURCE 2	3.	P-SOURCE
GATE	4.	GATE 2	4.	P-GATE
DRAIN	5.	DRAIN 2	5.	P-DRAIN
DRAIN	6.	DRAIN 2	6.	P-DRAIN
7. DRAIN	7.	DRAIN 1	7.	N-DRAIN
8. Drain	8.	DRAIN 1	8.	N-DRAIN

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DESCRIPTION:	MICRO8		PAGE 1 OF 1

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